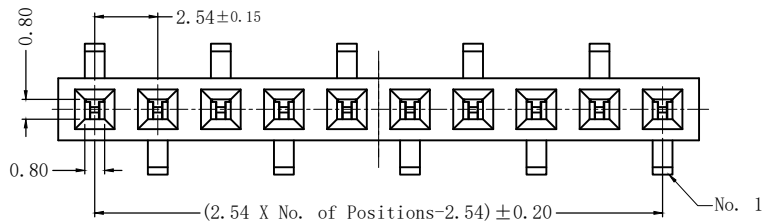
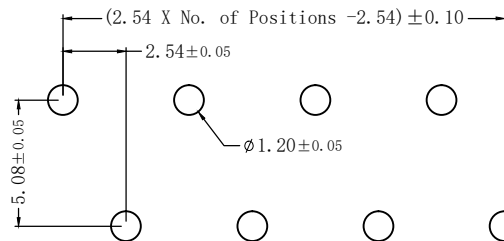
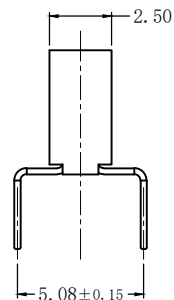
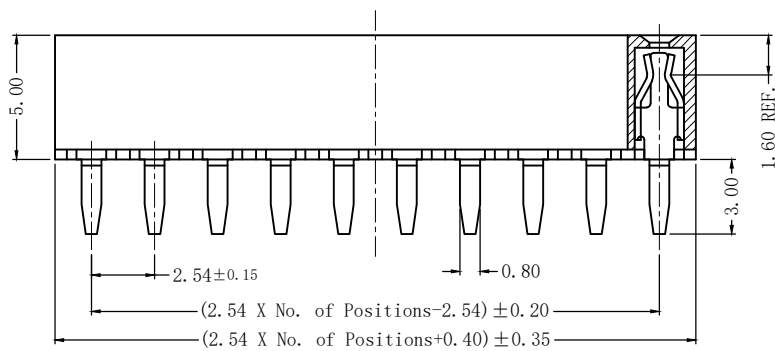
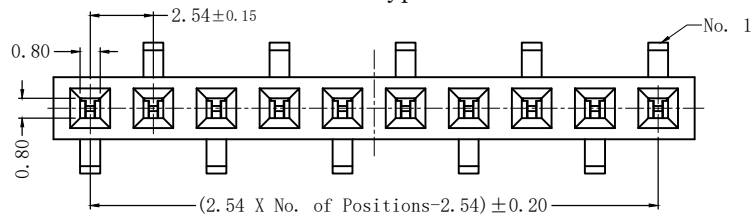


版次	变更内容	审核	日期

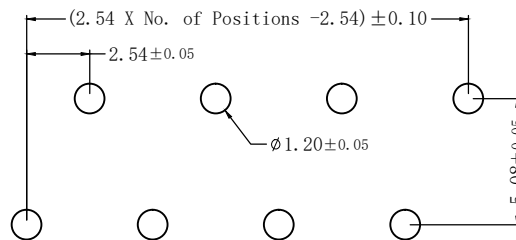
B1 Type



B2 Type



Recommended PCB Layout  
B1 Type



Recommended PCB Layout  
B2 Type

弯曲度: 1\*02P ~ 1\*20P 0.30 MAX.  
1\*21P ~ 1\*30P 0.40 MAX.  
1\*31P ~ 1\*40P 0.50 MAX.

插板类型: 205-Bx-1\*xxP G-A  
脚距: 5.08: 5.08mm  
B1: 第1Pin脚位朝下  
B2: 第1Pin脚位朝上  
芯数: 01~40P  
电镀: G: 镀金Gold Flash  
1G: 镀金1u"  
3G: 镀金3u"  
(镀金可订制)

技术参数: SPECIFICATIONS

额定电流 (Current Rating): 3A  
绝缘电阻 (Insulation Resistance): 1000Ω Min.  
接触电阻 (Contact Resistance): 20mΩ Max.  
额定电压 (Dielectric Withstanding Voltage): AC 500V  
工作温度 (Operating Temperature): -40°C ~ +105°C  
最大加工温度 (Max Processing Temp): (230°C for 30~60 seconds)  
(260°C for 10 seconds)  
接触材料 (Contact Material): 磷青铜(Phosphor Bronze), THICKNESS 0.40mm  
塑胶材料 (Insulator Material): 尼龙(Nylon)-9T, UL 94V-0, 颜色: 黑色  
接触电镀 (Contact Plating): 镀金 (Gold plated)  
(电镀规格可根据客户要求来定制)  
Optional plating on request.

公差:	版次:	A	上海宗进电子科技有限公司 Shanghai Zong Jin Electron Technology Co.LTD		
. X ±0.35	比例:		型号:	205-Bx-1*xxPG-A	签名
. XX ±0.25	单位:	mm	描述:	2.54单排蜈蚣脚排母	日期
. XXX ±2°	页码:	1/1	图号:		绘图:
LNLB	图号:				确认:
					审核: